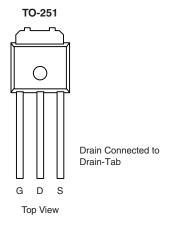


## P-Channel 100 V (D-S) 175 °C MOSFET

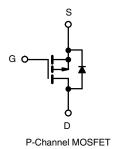
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 100				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.033				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.037				
I <sub>D</sub> (A)	- 40				
Configuration	Single				



### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- Package with Low Thermal Resistance
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





ABSOLUTE MAXIMUM RATINGS (	$\Gamma_{\rm C} = 25  ^{\circ}{\rm C}$ , unles	ss otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	- 100	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current	T <sub>C</sub> = 25 °C		- 40		
Continuous Drain Current	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	- 22		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 50	Α	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	- 150		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 44		
Single Pulse Avalanche Energy	L = 0.1 IIII	E <sub>AS</sub>	96	mJ	
Marrian Barras Biaria di anh	T <sub>C</sub> = 25 °C	P <sub>D</sub>	136	W	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 125 °C	ı D	45	VV	
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>c</sup>	$R_{thJA}$	50	°C/W
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.1	C/VV

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					l	l		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, I <sub>D</sub> = - 250 μA	- 100	-	-	.,	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 1.0	-	-2.5	, v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 100 V	-	-	- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = - 100 V, T <sub>J</sub> = 125 °C	-	-	- 50	μΑ	
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 100 V, T <sub>J</sub> = 175 °C	-	-	- 250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = - 10 V	V <sub>DS</sub> ≤ - 5 V	- 30	-	-	Α	
		V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 9.2 A	-	0.033	-	V nA μA A Ω S pF nC Ω ns	
Durin On the On Older Business	В	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 9.2 A, T <sub>J</sub> = 125 °C	-	0.074	-		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 9.2 A, T <sub>J</sub> = 175 °C	-	0.093	-		
		V <sub>GS</sub> = - 4.5 V	I <sub>D</sub> = - 7.7 A	-	0.037	-		
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub> =	- 15 V, I <sub>D</sub> = - 9.2 A	-	35	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			-	4433	5545		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = - 25 V, f = 1 MHz	-	301	380	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	208	260	1	
Total Gate Charge <sup>c</sup>	Qg			-	96	144		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	$V_{DS} = -50V, I_{D} = -9.2 A$	-	8.4	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	23.5	-	]	
Gate Resistance	R <sub>g</sub>		f = 1 MHz	1.5	3.13	4.7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	11	17		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -50 \text{ V}, R_L = 6.49 \Omega$ - 11 $I_D \cong -7.7 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1.0 \Omega$ - 78  - 15		11	17	1		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			117	IIS			
Fall Time <sup>c</sup>	t <sub>f</sub>			-	15	23		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>	•						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 150	Α	
Forward Voltage	V <sub>SD</sub>	+ .	- 7.7 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.5	t	

#### Notes

2

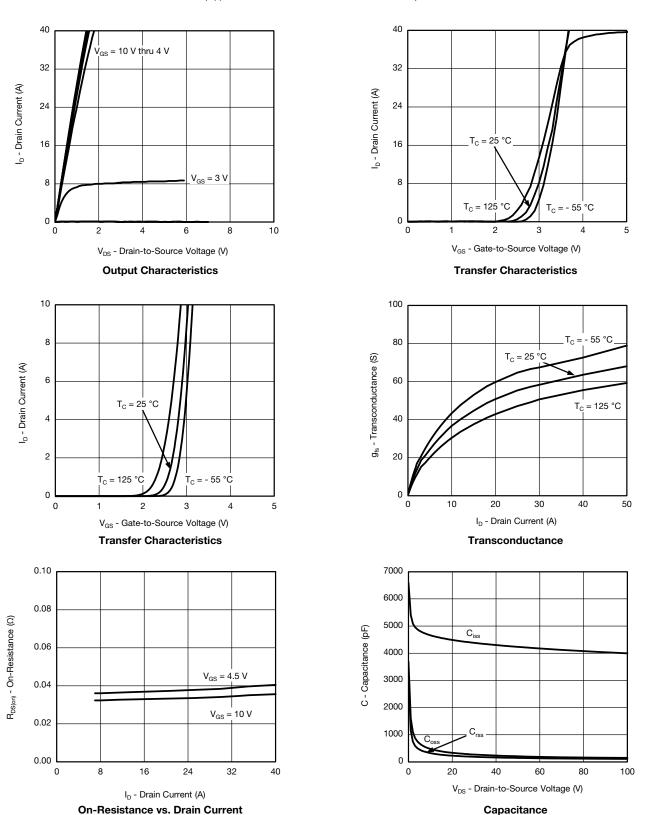
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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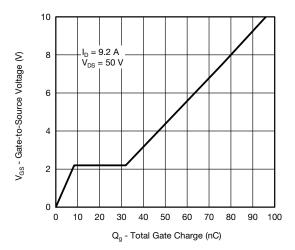
### **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



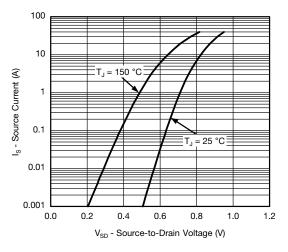
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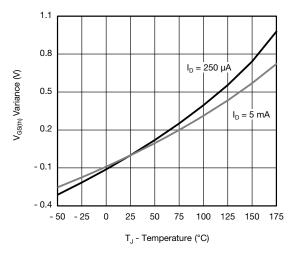
### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \, ^{\circ}\text{C}$ , unless otherwise noted)



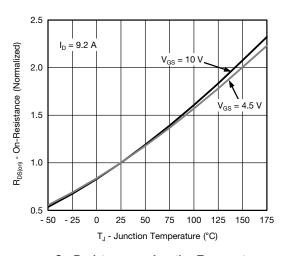
### **Gate Charge**



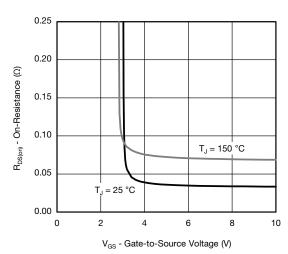
**Source Drain Diode Forward Voltage** 



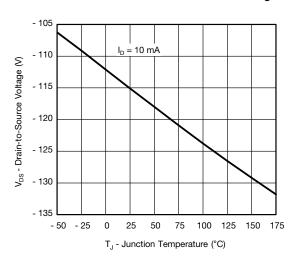
**Threshold Voltage** 



On-Resistance vs. Junction Temperature



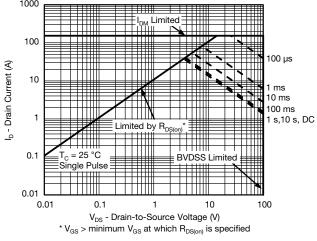
On-Resistance vs. Gate-to-Source Voltage



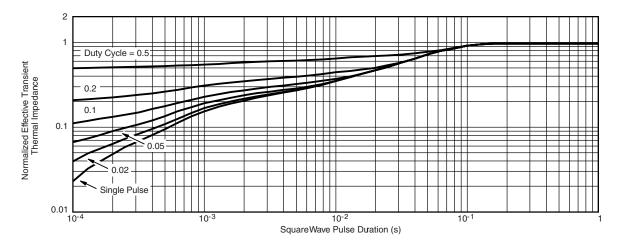
**Drain Source Breakdown vs. Junction Temperature** 



### **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

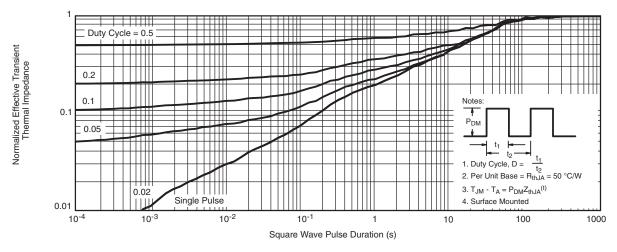


Normalized Thermal Transient Impedance, Junction-to-Case

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### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Ambient

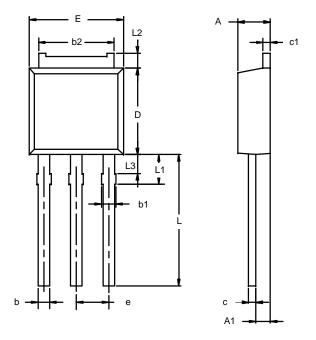
#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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### **TO-251AA**



Note: Dimension L3 is for reference only.

	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
<b>A</b> 1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28	BSC	0.090	BSC
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060

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